

LED Drivers for LCD Backlights
Multifunction Backlight LED Drivers

for Small LCD Panels (Charge Pump Type)

BD6085GUL

No.11040EAT28

RoHS

Description

BD6085GUL is Multi-Function LED Driver that is the most suitable for the cellular phone. It has many functions that are needed to "the upper side" of the cellular phone.

Features

1) Total 7LEDs driver for LCD Backlight (Main/Sub) and LED Flash It can set maximum 30mA by 32 steps (Current DAC) for Main/Sub Display It can set maximum 360mA for Flash LED driver (It has 3 channels LED driver at maximum 120mA/ch for Flash.) The number of lighting for Main/Sub/Flash LED can be set up grouping by register.
Ex.) 4LEDs / 0LED / 3LEDs 4LEDs / 0LED / 3LEDs 4LEDs / 1LED / 2LEDs 4LEDs / 1LED / 1LED 5LEDs / 1LED / 1LED 5LEDs / 0LED / 1LED
It can use the 1LED Flash module to 3LED Flash module. Normal mode = maximum 30mA/ch, Flash mode = x4 normal mode (for 3ch LED).

The grouping of LED is independently controlled by register.

- 4ch Šeries Řegulator (LDO) It has selectable output voltage by the register. LDO1,LDO2 : lomax=200mA LDO3,LDO4 : lomax=150mA
- Charge Pump DC/DC for LED driver It has x1/x1.33/x1.5/x2 mode that will be selected automatically. Soft start functions Over voltage protection (Auto-return type) Over current protection (Auto-return type)
- 4) Thermal shutdown (Auto-return type)
- 5) I²C BUS FS mode(max 400kHz)Write/Read
- 6) VCSP50L3(3.30mm × 3.30mm, 0.55mm) Small and thin CSP package

*This chip is not designed to protect itself against radioactive rays.

*This material may be changed on its way to designing. *This material is not the official specification.

●Absolute Maximum Ratings (Ta=25 °C)

Parameter	Symbol	Ratings	Unit							
Maximum voltage	VMAX	7	V							
Power Dissipation	Pd	1325	mW							
Operating Temperature Range	Topr	-35 ~ +85	°C							
Storage Temperature Range	Tstg	-55 ~ +150	°C							
Storage Temperature Range	5		C							

note)Power dissipation deleting is 10.6mW/ °C, when it's used in over 25 °C.

(It's deleting is on the board that is ROHM's standard)

●Operating conditions (VBAT≥VIO, Ta=-35~85 °C)

Parameter	Symbol	Ratings	Unit
VBAT input voltage	VBAT	2.7~5.5	V
VIO pin voltage	VIO	1.65~3.3	V

●Electrical Characteristics (Unless otherwise specified, Ta=25°C, VBAT=3.6V, VIO=1.8V)

Parameter Sym			Limits	0.07,			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
[Circuit Current]							
VBAT Circuit current 1	IBAT1	-	0.1	1.0	μA	RESETB=0V, VIO=0V	
VBAT Circuit current 2	IBAT2	-	0.5	3.0	μA	RESETB=0V, VIO=1.8V	
VBAT Circuit current 3	IBAT3	-	90	150	μA	LDO1=LDO2=ON, I _{LDO} =0mA Other blocks=OFF LDO3=LDO4=ON, I _{LDO} =0mA	
VBAT Circuit current 4	IBAT4	-	90	150	μA	Other blocks=OFF LDO1=LDO2=ON, I _{LDO} =0mA	
VBAT Circuit current 5	IBAT5	-	390	600	μA	DC/DC x1mode, I _{LED} =2.8125(30x3/32)mA x 4ch	
VBAT Circuit current 6	IBAT6	-	61	65	mA	DC/DC x1mode, I _{LED} =60mA VBAT=3.7V, LED Vf=3.0V	
VBAT Circuit current 7	IBAT7	-	84	94	mA	DC/DC x1.33mode, I _{LED} =60mA VBAT=3.1V, LED Vf=3.0V	
VBAT Circuit current 8	IBAT8	-	94	104	mA	DC/DC x1.5 mode, I _{LED} =60mA VBAT=2.9V, LED VF=3.5V	
VBAT Circuit current 9	IBAT9	-	128	136	mA	DC/DC x2 mode, I _{LED} =60mA VBAT=2.9V, LED Vf=4.0V	
【LED Driver】							
LED current Step	ILEDSTP		32	1	Step	LED1~7	
White LED Maximum setup current	IMAXWLED	-	30	-	mA	LED1~7 (Normal mode)	
Flash LED Maximum setup current	IMAXFLED	-	120	-	mA	LED5~7 (Flash mode)	
White LED current accuracy	IWLED	-7%	15	+7%	mA	I _{LED} =15mA setting (Normal mode) At VLED=1.0V	
Flash LED current accuracy	IFLED	-	60	-	mA	I _{LED} =60mA setting (Flash mode) At VLED=1.0V	
LED current Matching	ILEDMT	-	-	4	%	Between LED1~7 at VLED=1.0V	
Flash / Normal current ratio	RATFL	3.2	4	4.8	A/A	LED5~7, Flash mode/Normal mode At VLED=1.0V	
LED OFF Leak current	ILKLED	-	-	1.0	μA	VLED=4.5V	
[DC/DC(Charge Pump)]				1	[
Maximum Output voltage	V°CP	4.65	5.1	5.55	V		
Current Load	IOUT	-	-	480	mA	VBAT≥3.2V, VOUT=4V	
Oscillator frequency	fosc	0.72	0.9	1.08	MHz		
Over Voltage Protection detect voltage	OVP	5.0	5.5	6.0	V		
Short Circuit current limit	llim	-	250	500	mA	VOUT=0V	
【I ² C Input (SDA, SCL)】				0.05	[
LOW level input voltage	VIL	-0.3	-	0.25 × VIO	V		
HIGH level input voltage	VIH	0.75 × VIO	-	VBAT +0.3	V		
Hysteresis of Schmitt trigger input LOW level output voltage	Vhys	0.05 × VIO	-	-	V		
(SDA) at 3mA sink current	VOL	0	-	0.3	V		
Input current each I/O pin	lin	-3	-	3	μA	Input voltage = 0.1×VIO~0.9×VIO	
[RESETB] LOW level input voltage	VIL	-0.3	_	0.25 ×	V		
HIGH level input voltage	VIL	0.75 ×		VIO VBAT	V		
Input current each I/O pin	lin	VIO -3	-	+0.3	μA	Input voltage = 0.1×VIO~0.9×VIO	
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•Electrical Characteristics (Unless otherwise specified, Ta=25°C, VBAT=3.6V, VIO=1.8V)

Deservator	Ourschart		Limits		11	O and difficure
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
【Regulator (LDO1)】						
		1.164	1.20	1.236	V	lo=50mA
		1.261	1.30	1.339	V	lo=50mA
		1.455	1.50	1.545	V	lo=50mA
		1.552	1.60	1.648	V	lo=50mA
		1.746	1.80	1.854	V	Io=50mA <initial voltage=""></initial>
		2.134	2.20	2.266	V	lo=50mA
		2.328	2.40	2.472	V	lo=50mA
Output voltage	Vo1	2.425	2.50	2.575	V	lo=50mA
Output voltage	VOT	2.522	2.60	2.678	V	lo=50mA
		2.619	2.70	2.781	V	lo=50mA
		2.716	2.80	2.884	V	lo=50mA
		2.813	2.90	2.987	V	lo=50mA
		2.910	3.00	3.090	V	lo=50mA
		3.007	3.10	3.193	V	lo=50mA
		3.104	3.20	3.296	V	lo=50mA
		3.201	3.30	3.399	V	lo=50mA
Output Current	lo1	-	-	200	mA	Vo=1.8V
Dropout Voltage	Vsat1	-	0.2	0.3	V	VBAT=2.5V, Io=200mA, Vo=2.8V
Load stability	ΔVo11	-	10	60	mV	lo=1~200mA, Vo=1.8V
Input voltage stability	ΔVo12	-	10	60	mV	VBAT=3.4~4.5V, Io=50mA, Vo=1.8V
				00		f=100Hz, Vin=200mVp-p, Vo=1.2V
Ripple Rejection Ratio	RR1	-	65	-	dB	lo=50mA, BW=20Hz~20kHz
Short circuit current limit	llim1	-	250	500	mA	Vo=0V
Discharge resister at OFF	ROFF1	-	1.0	1.5	kΩ	
[Regulator (LDO2)]						I
		1.164	1.20	1.236	V	lo=50mA
		1.261	1.30	1.339	V	lo=50mA
		1.455	1.50	1.545	V	lo=50mA
		1.552	1.60	1.648	V	lo=50mA
		1.746	1.80	1.854	V	lo=50mA
		2.134	2.20	2.266	V	lo=50mA
		2.328	2.40	2.472	V	lo=50mA
		2.425	2.50	2.575	V	Io=50mA <initial voltage=""></initial>
Output voltage	Vo2	2.522	2.60	2.678	V	lo=50mA
		2.619	2.70	2.781	V	lo=50mA
		2.716	2.80	2.884	V	lo=50mA
		2.813	2.90	2.987	V	lo=50mA
		2.910	3.00	3.090	V	lo=50mA
		3.007	3.10	3.193	V	lo=50mA
		3.104	3.20	3.296	V	lo=50mA
		3.201	3.30	3.399	V	lo=50mA
Output Current	lo2	-	-	200	mA	Vo=2.5V
Dropout Voltage	Vsat2	_	0.2	0.3	V	VBAT=2.5V, Io=200mA, Vo=2.8V
Load stability	Δνο21	_	10	60	mV	lo=1~200mA, Vo=2.5V
-			10	60	mV	VBAT=3.4~4.5V, Io=50mA, Vo=2.5V
Input voltage stability	Δνο22	-	10	00	IIIV	f=100Hz, Vin=200mVp-p, Vo=1.2V
Ripple Rejection Ratio	RR2	-	65	-	dB	Io=50mA, BW=20Hz~20kHz
Short circuit current limit	llim2	-	250	500	mA	Vo=0V
Discharge resister at OFF	ROFF2	-	1.0	1.5	kΩ	

•Electrical Characteristics (Unless otherwise specified, Ta=25°C, VBAT=3.6V, VIO=1.8V)

			Limits			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
[Regulator (LDO3)]				I		
		1.164	1.20	1.236	V	lo=50mA
		1.261	1.30	1.339	V	Io=50mA
		1.455	1.50	1.545	V	lo=50mA
		1.552	1.60	1.648	V	lo=50mA
		1.746	1.80	1.854	V	Io=50mA <initial voltage=""></initial>
		2.134	2.20	2.266	V	Io=50mA
		2.328	2.40	2.472	V	Io=50mA
		2.425	2.50	2.575	V	Io=50mA
Output voltage	Vo3	2.522	2.60	2.678	V	Io=50mA
		2.619	2.70	2.781	V	lo=50mA
		2.716	2.80	2.884	V	lo=50mA
		2.813	2.90	2.987	V	Io=50mA
		2.910	3.00	3.090	V	Io=50mA
		3.007	3.10	3.193	V	Io=50mA
		3.104	3.20	3.296	V	Io=50mA
		3.201	3.30	3.399	V	Io=50mA
Output Current	lo3	-	-	150	mA	Vo=1.8V
Dropout Voltage	Vsat3	_	0.2	0.3	V	VBAT=2.5V, lo=150mA, Vo=2.8V
Load stability	Δνο31	_	10	60	mV	lo=1~150mA, Vo=1.8V
Input voltage stability	Δνο32		10	60	mV	VBAT=3.4~4.5V, Io=50mA, Vo=1.8V
	20032	-	10	00	IIIV	f=100Hz, Vin=200mVp-p, Vo=1.2V
Ripple Rejection Ratio	RR3	-	65	-	dB	Io=50mA, BW=20Hz~20kHz
Short circuit current limit	llim3	-	200	400	mA	Vo=0V
Discharge resister at OFF	ROFF3	-	1.0	1.5	kΩ	
【Regulator (LDO4)】	1					
		1.164	1.20	1.236	V	Io=50mA
		1.261	1.30	1.339	V	Io=50mA
		1.455	1.50	1.545	V	Io=50mA
		1.552	1.60	1.648	V	Io=50mA
		1.746	1.80	1.854	V	Io=50mA
		2.134	2.20	2.266	V	Io=50mA
		2.328	2.40	2.472	V	Io=50mA
Output voltage	Vo4	2.425	2.50	2.575	V	Io=50mA
Culput Voltage	V0 4	2.522	2.60	2.678	V	Io=50mA
		2.619	2.70	2.781	V	Io=50mA
		2.716	2.80	2.884	V	Io=50mA <initial voltage=""></initial>
		2.813	2.90	2.987	V	Io=50mA
		2.910	3.00	3.090	V	Io=50mA
		3.007	3.10	3.193	V	Io=50mA
		3.104	3.20	3.296	V	Io=50mA
		3.201	3.30	3.399	V	Io=50mA
Output Current	lo4	-	-	150	mA	Vo=2.8V
Dropout Voltage	Vsat4	-	0.2	0.3	V	VBAT=2.5V, Io=150mA, Vo=2.8V
Load stability	Δvo41	-	10	60	mV	lo=1~150mA, Vo=2.8V
Input voltage stability	Δvo42	-	10	60	mV	VBAT=3.4~4.5V, Io=50mA, Vo=2.8V
Ripple Rejection Ratio	RR4	-	65	-	dB	f=100Hz, Vin=200mVp-p, Vo=1.2V Io=50mA, BW=20Hz~20kHz
Short circuit current limit	llim4	-	200	400	mA	Vo=0V
Discharge resister at OFF	ROFF4	-	1.0	1.5	kΩ	

Block Diagram / Application Circuit example

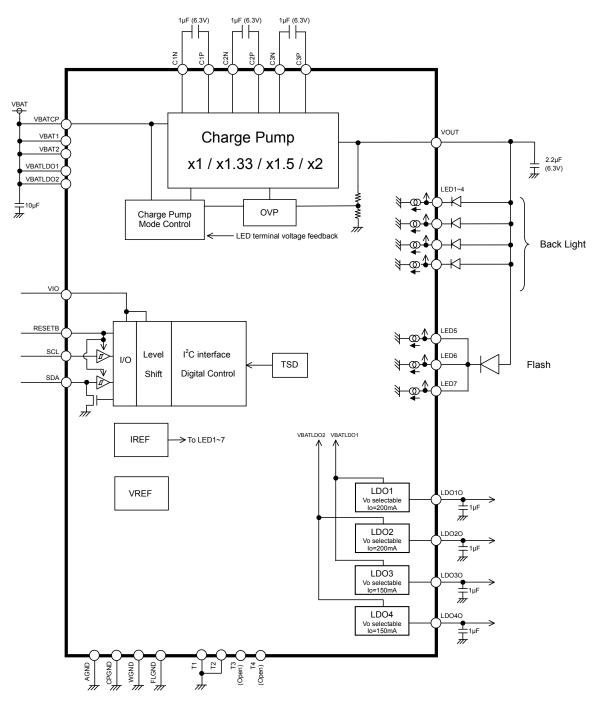


Fig.1 Block Diagram / Application Circuit example 1 Back Light (4ch) + Flash (total 360mA)

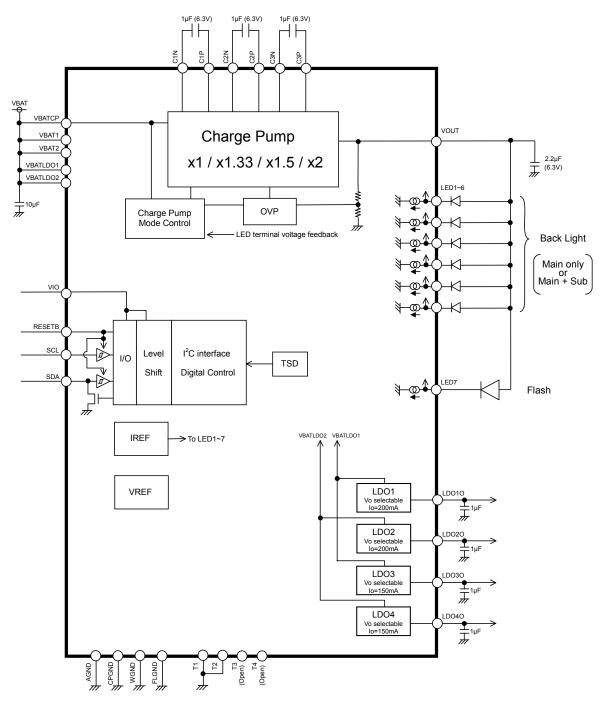


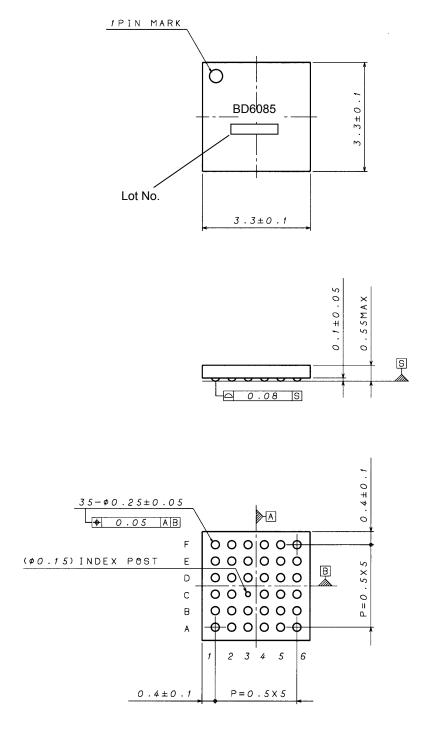
Fig.2 Block Diagram / Application Circuit example 2 Back Light (6ch) + Flash (max 120mA)

F	T4	VBATLDO2	VBAT1	AGND	VBATLDO1	Т3
E	LDO2O	LDO4O	VBAT2	LDO3O	LDO10	VIO
D	LED6	LED7	RESETB	SCL	SDA	C1N
С	LED5	FLGND		CPGND	C2N	C1P
В	LED4	WGND	LED2	VOUT	C2P	VBATCP
A	T1	LED3	LED1	C3N	C3P	T2
	1	2	3	4	5	6

Index

Total: 35balls

VCSP50L3 SIZE : 3.30mm × 3.30mm A ball pitch : 0.5mm Height : 0.55mm max



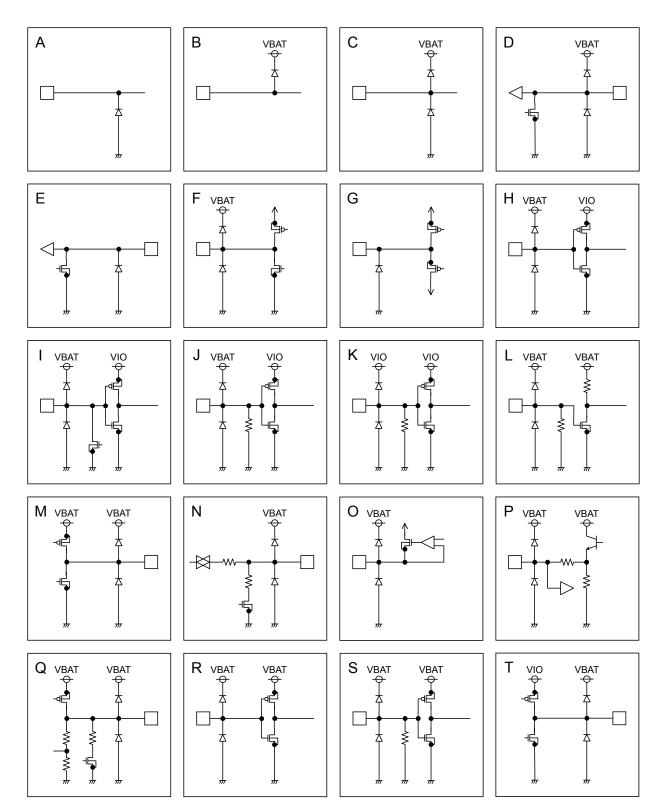
Pin Functions

NoBall No.Pin NameI/OESD Diode For PowerFor GroundFunctionsEquivalent Circuit1B6VBATCPGNDPower supply for charge pumpA3E3VBAT1GNDPower supplyA4F5VBATLDO1GNDPower supply for LDOA5F2VBATLDO2GNDPower supply for LDOA6A1T1IVBATGNDTest Input Pin (short to Ground)S7A6T2IVBATGNDTest Input Pin (short to Ground)S8F6T3OVBATGNDTest Output Pin (Open)M9F1T4OVBATGNDTest Output Pin (Open)N10E6VIO-VBATGNDReset Pint (Lir seet, Hir reset cancel)H11D3RESETBIVBATGNDFC data input / Lir seet, Hir reset cancel)H12D5SDAI/OVBATGroundB15F4AGND-VBAT-GroundB16B2WGND-VBAT-GroundB17C2FLGND-VBAT-GroundB18D6C1NI/OVBATGNDCharge Pump capacitor is connectedF20C5C2NI/O-GNDCharge Pump capa		1000113			FOD	Diada		
No. Power Ground Curcuit 1 B6 VBATCP - GND Power supply for charge pump A 2 F3 VBAT1 - GND Power supply for charge pump A 3 E3 VBAT2 - GND Power supply for LDO A 4 F5 VBATLOD1 - GND Power supply for LDO A 6 A1 T1 I VBAT GND Test Input Pin (short to Ground) S 7 A6 T2 I VBAT GND Test Input Pin (open) M 9 F1 T4 O VBAT GND Test Output Pin (Open) N 10 E6 VIO - VBAT GND Reset input (L: reset, H: reset cancel) H 11 D3 RESETB I VBAT GND Fc dock input I 13 D4 SCL I VBAT Ground B B <td>Na</td> <td>Ball</td> <td></td> <td>VO</td> <td></td> <td></td> <td>Eurotione</td> <td>Equivalent</td>	Na	Ball		VO			Eurotione	Equivalent
1 B6 VBATCP - GND Power supply for charge pump A 2 F3 VBAT1 - - GND Power supply A 4 F5 VBATLDO1 - - GND Power supply for LDO A 4 F5 VBATLDO2 - GND Power supply for LDO A 6 A1 T1 I VBAT GND Test Input Pin (short to Ground) S 7 A6 T2 I VBAT GND Test Input Pin (short to Ground) S 8 F6 T3 O VBAT GND Test Output Pin (Open) M 10 E6 VIO - VBAT GND Power supply for I/O and Digital C 11 D3 RESETB I VBAT GND Power supply for I/O and Digital C 12 D5 SDA I/O VBAT GND Power supply capacitor is connected F 13	INO	No.	Pin Name	1/0	-	-	Functions	Circuit
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	1	B6		_	Power		Power supply for charge nump	Δ
3 E3 VBAT2 - GND Power supply A 4 F5 VBATLDO1 - GND Power supply for LDO A 5 F2 VBATLDO2 - GND Power supply for LDO A 6 A1 T1 I VBAT GND Test Input Pin (short to Ground) S 7 A6 T2 I VBAT GND Test Input Pin (open) M 9 F1 T4 O VBAT GND Test Output Pin (Open) N 10 E6 VIO - VBAT GND Reset tinput (L: reset, H: reset cancel) H 11 D3 RESETB I VBAT GND I ² C data input / output I 13 D4 SCL I VBAT GND I ² C dock input H 14 C4 CPGND - VBAT - Ground B 15 F4 AGND - <t< td=""><td></td><td>-</td><td></td><td></td><td>-</td><td></td><td></td><td></td></t<>		-			-			
4 F5 VBATLDO1 - - GND Power supply for LDO A 5 F2 VBATLDO2 - - GND Power supply for LDO A 6 A1 T1 I VBAT GND Test Input Pin (short to Ground) S 7 A6 T2 I VBAT GND Test Input Pin (short to Ground) S 8 F6 T3 O VBAT GND Test Input Pin (Open) M 9 F1 T4 O VBAT GND Power supply for I/O and Digital C 10 E6 VIO - VBAT GND Power supply for I/O and Digital C 11 D3 RESETB I VBAT GND Power supply for I/O and Digital C 12 D5 SDA I/O WBAT GND I ² C dack input H 14 C4 CPGND - VBAT - Ground B				-	-			
5 F2 VBATLDO2 - - GND Power supply for LDO A 6 A1 T1 I VBAT GND Test Input Pin (short to Ground) S 7 A6 T2 I VBAT GND Test Input Pin (short to Ground) S 8 F6 T3 O VBAT GND Test Output Pin (Open) M 9 F1 T4 O VBAT GND Test Output Pin (Open) N 10 E6 VIO - VBAT GND Power supply for I/O and Digital C 11 D3 RESETB I VBAT GND Power supply for I/O and Digital C 12 D5 SDA I/O VBAT GND I* reset cancel) H 14 C4 CPGND - VBAT Ground B 15 F4 AGND - VBAT - Ground B 16 B2	-			-	-			
6 A1 T1 I VBAT GND Test Input Pin (short to Ground) S 7 A6 T2 I VBAT GND Test Input Pin (short to Ground) S 8 F6 T3 O VBAT GND Test Output Pin (Open) M 9 F1 T4 O VBAT GND Test Output Pin (Open) N 10 E6 VIO - VBAT GND Reset input (L: reset, H: reset cancel) H 11 D3 RESETB I VBAT GND Reset input (L: reset, H: reset cancel) H 13 D4 SCL I VBAT Ground B 14 C4 CPGND - VBAT - Ground B 15 F4 AGND - VBAT - Ground B 16 B2 WGND - VBAT - Ground B 17 C2 FLGND	-				-			
7 A6 T2 I VBAT GND Test Input Pin (short to Ground) S 8 F6 T3 O VBAT GND Test Output Pin (Open) M 9 F1 T4 O VBAT GND Test Output Pin (Open) N 10 E6 VIO - VBAT GND Power supply for I/O and Digital C 11 D3 RESETB I VBAT GND Power supply for I/O and Digital C 12 D5 SDA I/O VBAT GND Power supply for I/O and Digital C 13 D4 SCL I VBAT GND I ² C clock input H 14 C4 CPGND - VBAT - Ground B 15 F4 AGND - VBAT - Ground B 16 B2 WGND - VBAT GND Charge Pump capacitor is connected F <td< td=""><td>-</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td></td<>	-							
8 F6 T3 O VBAT GND Test Output Pin (Open) M 9 F1 T4 O VBAT GND Test Output Pin (Open) N 10 E6 VIO - VBAT GND Power supply for I/O and Digital C 11 D3 RESETB I VBAT GND Reset input / L: reset cancel) H 12 D5 SDA I/O VBAT GND Reset input / output I 13 D4 SCL I VBAT GND I ² C clack input H 14 C4 CPGND - VBAT Ground B 15 F4 AGND - VBAT - Ground B 16 B2 WGND - VBAT - Ground B 17 C2 FLGND - VBAT GND Charge Pump capacitor is connected F 19 C6 C1P	-							
9 F1 T4 O VBAT GND Test Output Pin (Open) N 10 E6 VIO - VBAT GND Power supply for I/O and Digital C 11 D3 RESETB I VBAT GND Reset input (:reset, H: reset cancel) H 12 D5 SDA I/O VBAT GND I'C data input / output I 13 D4 SCL I VBAT GND I'C clock input H 14 C4 CPGND - VBAT - Ground B 15 F4 AGND - VBAT - Ground B 16 B2 WGND - VBAT - Ground B 17 C2 FLGND - VBAT Ground Charge Pump capacitor is connected F 19 C6 C1P I/O - GND Charge Pump capacitor is connected F 21							,	
10 E6 VIO - VBAT GND Power supply for I/O and Digital C 11 D3 RESETB I VBAT GND Reset input (L: reset, H: reset cancel) H 12 D5 SDA I/O VBAT GND I ² C data input / output I 13 D4 SCL I VBAT GND I ² C clock input H 14 C.4 CPGND - VBAT Ground B 15 F4 AGND - VBAT - Ground B 16 B2 WGND - VBAT - Ground B 17 C2 FLGND - VBAT - Ground B 18 D6 C1N I/O VBAT GND Charge Pump capacitor is connected F 21 B5 C2P I/O - GND Charge Pump capacitor is connected F 23 A5 C3								
11D3RESETBIVBATGNDReset input (L: reset, H: reset cancel)H12D5SDAI/OVBATGNDI²C data input / outputI13D4SCLIVBATGNDI²C clock inputH14C4CPGND-VBATGroundB15F4AGND-VBAT-GroundB16B2WGND-VBAT-GroundB17C2FLGND-VBAT-GroundB18D6C1NI/OVBATGNDCharge Pump capacitor is connectedF19C6C1PI/O-GNDCharge Pump capacitor is connectedG20C5C2NI/O-GNDCharge Pump capacitor is connectedF21B5C2PI/O-GNDCharge Pump capacitor is connectedG22A4C3NI/OVBATGNDCharge Pump capacitor is connectedF23A5C3PI/O-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG27E4LD03OOVBATGNDLDO2 output pinQ28E2LD04OOVBATGNDLDO2 output pinQ <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td>								
12D5SDAI/OVBATGNDI²C data input / outputI13D4SCLIVBATGNDI²C clock inputH14C4CPGND-VBAT-GroundB15F4AGND-VBAT-GroundB16B2WGND-VBAT-GroundB17C2FLGND-VBAT-GroundB18D6C1NI/OVBATGNDCharge Pump capacitor is connectedF19C6C1PI/O-GNDCharge Pump capacitor is connectedF20C5C2NI/O-GNDCharge Pump capacitor is connectedF21B5C2PI/O-GNDCharge Pump capacitor is connectedF23A5C3PI/O-GNDCharge Pump capacitor is connectedF23A5C3PI/O-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG27E4LDO2OOVBATGNDLDO2 output pinQ28E2LDO4OOVBATGNDLDO2 output pinQ29A3LED11-GNDLED cathode connection 1 (for Back Light)E30B3LED21-GNDLED cathode connection 3 (for Back Light) </td <td>-</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td>	-							
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15F4AGND-VBAT-GroundB16B2WGND-VBAT-GroundB17C2FLGND-VBAT-GroundB18D6C1NI/OVBATGNDCharge Pump capacitor is connectedF19C6C1PI/O-GNDCharge Pump capacitor is connectedG20C5C2NI/O-GNDCharge Pump capacitor is connectedF21B5C2PI/O-GNDCharge Pump capacitor is connectedG22A4C3NI/OVBATGNDCharge Pump capacitor is connectedF23A5C3PI/O-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDLDO1 output pinQ26E1LDO2OOVBATGNDLDO2 output pinQ28E2LDO4OOVBATGNDLDO4 output pinQ29A3LED1I-GNDLED cathode connection 2 (for Back Light)E31A2LED3I-GNDLED catho								
16B2WGND-VBAT-GroundB17C2FLGND-VBAT-GroundB18D6C1NI/OVBATGNDCharge Pump capacitor is connectedF19C6C1PI/O-GNDCharge Pump capacitor is connectedG20C5C2NI/OVBATGNDCharge Pump capacitor is connectedF21B5C2PI/O-GNDCharge Pump capacitor is connectedG22A4C3NI/OVBATGNDCharge Pump capacitor is connectedF23A5C3PI/O-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDLDO1 output pinQ26E1LDO2OOVBATGNDLDO2 output pinQ28E2LDO4OOVBATGNDLED cathode connection 1 (for Back Light)E30B3LED21-GNDLED cathode connection 3 (for Back Light)E33C1LED51-GNDLED cathode connection 5 (for Back Light)E34D1				-		-		
17C2FLGND-VBAT-GroundB18D6C1NI/OVBATGNDCharge Pump capacitor is connectedF19C6C1PI/O-GNDCharge Pump capacitor is connectedG20C5C2NI/OVBATGNDCharge Pump capacitor is connectedF21B5C2PI/O-GNDCharge Pump capacitor is connectedG22A4C3NI/OVBATGNDCharge Pump capacitor is connectedF23A5C3PI/O-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDLDO1 output pinQ25E5LDO1OOVBATGNDLDO2 output pinQ26E1LDO2OOVBATGNDLDO2 output pinQ27E4LDO3OOVBATGNDLDO3 output pinQ28E2LDO4OOVBATGNDLED cathode connection 1 (for Back Light)E30B3LED2 <td></td> <td></td> <td></td> <td>-</td> <td></td> <td>-</td> <td></td> <td></td>				-		-		
18D6C1NI/OVBATGNDCharge Pump capacitor is connectedF19C6C1PI/O-GNDCharge Pump capacitor is connectedG20C5C2NI/OVBATGNDCharge Pump capacitor is connectedF21B5C2PI/O-GNDCharge Pump capacitor is connectedG22A4C3NI/OVBATGNDCharge Pump capacitor is connectedG23A5C3PI/O-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG25E5LDO10OVBATGNDLDO1 output pinQ26E1LDO20OVBATGNDLDO2 output pinQ27E4LDO30OVBATGNDLDO4 output pinQ29A3LED1I-GNDLED cathode connection 1 (for Back Light)E30B3LED2I-GNDLED cathode connection 3 (for Back Light)E31A2LED3I-GNDLED cathode connection 4 (for Back Light)E33C1LED5I-GNDLED cathode connection 5 (for Back Li				-		-		
19C6C1PI/O-GNDCharge Pump capacitor is connectedG20C5C2NI/OVBATGNDCharge Pump capacitor is connectedF21B5C2PI/O-GNDCharge Pump capacitor is connectedG22A4C3NI/OVBATGNDCharge Pump capacitor is connectedF23A5C3PI/O-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump capacitor is connectedG25E5LDO1OOVBATGNDLDO1 output pinQ26E1LDO2OOVBATGNDLDO2 output pinQ27E4LDO3OOVBATGNDLDO4 output pinQ29A3LED1I-GNDLED cathode connection 1 (for Back Light)E30B3LED2I-GNDLED cathode connection 3 (for Back Light)E31A2LED3I-GNDLED cathode connection 4 (for Back Light)E33C1LED5I-GNDLED cathode connection 5 (for Back Light or Flash)E34D1LED6I-GNDLED cathode connection 6 (for Back Light or Flash)E				-		-		
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22A4C3NI/OVBATGNDCharge Pump capacitor is connectedF23A5C3PI/O-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump output pinA25E5LDO1OOVBATGNDLDO1 output pinQ26E1LDO2OOVBATGNDLDO2 output pinQ27E4LDO3OOVBATGNDLDO3 output pinQ28E2LDO4OOVBATGNDLDO4 output pinQ29A3LED1I-GNDLED cathode connection 1 (for Back Light)E30B3LED2I-GNDLED cathode connection 3 (for Back Light)E31A2LED3I-GNDLED cathode connection 4 (for Back Light)E32B1LED4I-GNDLED cathode connection 5 (for Back Light)E33C1LED5I-GNDLED cathode connection 5 (for Back Light or Flash)E34D1LED6I-GNDLED cathode connection 6 (for Back Light or Flash)E	20			I/O	VBAT	GND	Charge Pump capacitor is connected	F
23A5C3PI/O-GNDCharge Pump capacitor is connectedG24B4VOUTO-GNDCharge Pump output pinA25E5LDO1OOVBATGNDLDO1 output pinQ26E1LDO2OOVBATGNDLDO2 output pinQ27E4LDO3OOVBATGNDLDO3 output pinQ28E2LDO4OOVBATGNDLDO4 output pinQ29A3LED1I-GNDLED cathode connection 1 (for Back Light)E30B3LED2I-GNDLED cathode connection 3 (for Back Light)E31A2LED3I-GNDLED cathode connection 4 (for Back Light)E32B1LED4I-GNDLED cathode connection 5 (for Back Light)E33C1LED5I-GNDLED cathode connection 6 (for Back Light or Flash)E34D1LED6I-GNDLED cathode connection 6 (for Back Light or Flash)E	21	B5	C2P	I/O	-	GND	Charge Pump capacitor is connected	G
24B4VOUTO-GNDCharge Pump output pinA25E5LDO1OOVBATGNDLDO1 output pinQ26E1LDO2OOVBATGNDLDO2 output pinQ27E4LDO3OOVBATGNDLDO3 output pinQ28E2LDO4OOVBATGNDLDO4 output pinQ29A3LED1I-GNDLED cathode connection 1 (for Back Light)E30B3LED2I-GNDLED cathode connection 3 (for Back Light)E31A2LED3I-GNDLED cathode connection 4 (for Back Light)E32B1LED4I-GNDLED cathode connection 5 (for Back Light)E33C1LED5I-GNDLED cathode connection 5 (for Back Light or Flash)E34D1LED6I-GNDLED cathode connection 6 (for Back Light or Flash)E	22	A4	C3N	I/O	VBAT	GND	Charge Pump capacitor is connected	F
25E5LDO1OOVBATGNDLDO1 output pinQ26E1LDO2OOVBATGNDLDO2 output pinQ27E4LDO3OOVBATGNDLDO3 output pinQ28E2LDO4OOVBATGNDLDO4 output pinQ29A3LED1I-GNDLED cathode connection 1 (for Back Light)E30B3LED2I-GNDLED cathode connection 2 (for Back Light)E31A2LED3I-GNDLED cathode connection 3 (for Back Light)E32B1LED4I-GNDLED cathode connection 4 (for Back Light)E33C1LED5I-GNDLED cathode connection 5 (for Back Light or Flash)E34D1LED6I-GNDLED cathode connection 6 (for Back Light or Flash)E	23	A5	C3P	I/O	-	GND	Charge Pump capacitor is connected	G
26E1LDO2OOVBATGNDLDO2 output pinQ27E4LDO3OOVBATGNDLDO3 output pinQ28E2LDO4OOVBATGNDLDO4 output pinQ29A3LED1I-GNDLED cathode connection 1 (for Back Light)E30B3LED2I-GNDLED cathode connection 2 (for Back Light)E31A2LED3I-GNDLED cathode connection 3 (for Back Light)E32B1LED4I-GNDLED cathode connection 4 (for Back Light)E33C1LED5I-GNDLED cathode connection 5 (for Back Light or Flash)E34D1LED6I-GNDLED cathode connection 6 (for Back Light or Flash)E	24	B4	VOUT	0	-	GND	Charge Pump output pin	A
27E4LDO3OOVBATGNDLDO3 output pinQ28E2LDO4OOVBATGNDLDO4 output pinQ29A3LED1I-GNDLED cathode connection 1 (for Back Light)E30B3LED2I-GNDLED cathode connection 2 (for Back Light)E31A2LED3I-GNDLED cathode connection 3 (for Back Light)E32B1LED4I-GNDLED cathode connection 4 (for Back Light)E33C1LED5I-GNDLED cathode connection 5 (for Back Light or Flash)E34D1LED6I-GNDLED cathode connection 6 (for Back Light or Flash)E	25	E5	LDO10	0	VBAT	GND	LDO1 output pin	Q
28E2LDO4OOVBATGNDLDO4 output pinQ29A3LED1I-GNDLED cathode connection 1 (for Back Light)E30B3LED2I-GNDLED cathode connection 2 (for Back Light)E31A2LED3I-GNDLED cathode connection 3 (for Back Light)E32B1LED4I-GNDLED cathode connection 4 (for Back Light)E33C1LED5I-GNDLED cathode connection 5 (for Back Light or Flash)E34D1LED6I-GNDLED cathode connection 6 (for Back Light or Flash)E	26	E1	LDO2O	0	VBAT	GND	LDO2 output pin	Q
29A3LED1I-GNDLED cathode connection 1 (for Back Light)E30B3LED2I-GNDLED cathode connection 2 (for Back Light)E31A2LED3I-GNDLED cathode connection 3 (for Back Light)E32B1LED4I-GNDLED cathode connection 4 (for Back Light)E33C1LED5I-GNDLED cathode connection 5 (for Back Light or Flash)E34D1LED6I-GNDLED cathode connection 6 (for Back Light or Flash)E	27	E4	LDO3O	0	VBAT	GND	LDO3 output pin	Q
30B3LED2I-GNDLED cathode connection 2 (for Back Light)E31A2LED3I-GNDLED cathode connection 3 (for Back Light)E32B1LED4I-GNDLED cathode connection 4 (for Back Light)E33C1LED5I-GNDLED cathode connection 5 (for Back Light or Flash)E34D1LED6I-GNDLED cathode connection 6 (for Back Light or Flash)E	28	E2	LDO40	0	VBAT	GND	LDO4 output pin	Q
31A2LED3I-GNDLED cathode connection 3 (for Back Light)E32B1LED4I-GNDLED cathode connection 4 (for Back Light)E33C1LED5I-GNDLED cathode connection 5 (for Back Light or Flash)E34D1LED6I-GNDLED cathode connection 6 (for Back Light or Flash)E	29	A3	LED1	I	-	GND	LED cathode connection 1 (for Back Light)	E
32 B1 LED4 I - GND LED cathode connection 4 (for Back Light) E 33 C1 LED5 I - GND LED cathode connection 5 (for Back Light or Flash) E 34 D1 LED6 I - GND LED cathode connection 6 (for Back Light or Flash) E	30	B3	LED2	I	-	GND	LED cathode connection 2 (for Back Light)	E
33 C1 LED5 I - GND LED cathode connection 5 (for Back Light or Flash) E 34 D1 LED6 I - GND LED cathode connection 6 (for Back Light or Flash) E	31	A2	LED3	I	-	GND	LED cathode connection 3 (for Back Light)	E
34 D1 LED6 I - GND LED cathode connection 6 (for Back Light or Flash) E	32	B1		I	-	GND		E
34 D1 LED6 I - GND LED cathode connection 6 (for Back Light or Flash) E	33	C1	LED5	I	-	GND	LED cathode connection 5 (for Back Light or Flash)	E
	34	D1	LED6	I	-	GND		E
	35	D2	LED7	I	-	GND	LED cathode connection 7 (for Back Light or Flash)	

%The LED terminal that isn't used is to short-circuit to the ground. But, the setup of a register concerned with LED that isn't used is prohibited.

Total: 35Pin

Equivalent Circuit



●I²C BUS format

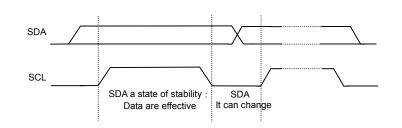
The writing/reading operation is based on the I^2C slave standard.

Slave address

ſ	A7	A6	A5	A4	A3	A2	A1	R/W
	1	1	1	0	1	1	0	1/0

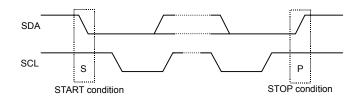
Bit Transfer

SCL transfers 1-bit data during H. SCL cannot change signal of SDA during H at the time of bit transfer. If SDA changes while SCL is H, START conditions or STOP conditions will occur and it will be interpreted as a control signal.



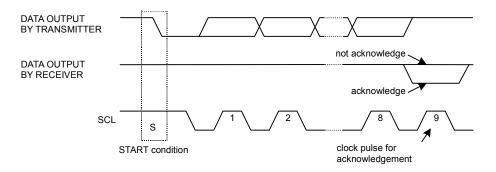
START and STOP condition

When SDA and SCL are H, data is not transferred on the I²C- bus. This condition indicates, if SDA changes from H to L while SCL has been H, it will become START (S) conditions, and an access start, if SDA changes from L to H while SCL has been H, it will become STOP (P) conditions and an access end.



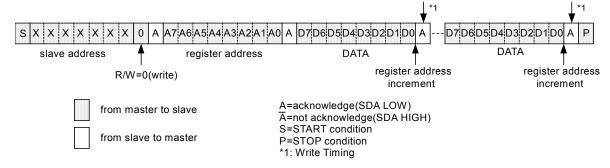
Acknowledge

It transfers data 8 bits each after the occurrence of START condition. A transmitter opens SDA after transfer 8bits data, and a receiver returns the acknowledge signal by setting SDA to L.



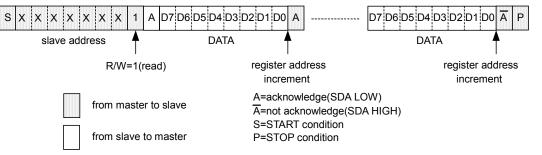
Writing protocol

A register address is transferred by the next 1 byte that transferred the slave address and the write-in command. The 3rd byte writes data in the internal register written in by the 2nd byte, and after 4th byte or, the increment of register address is carried out automatically. However, when a register address turns into the last address, it is set to 00h by the next transmission. After the transmission end, the increment of the address is carried out.



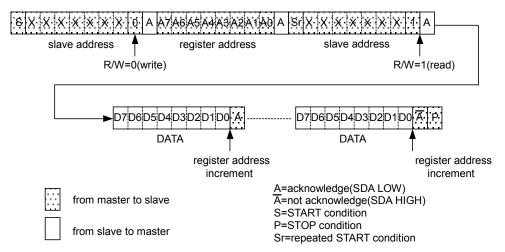
Reading protocol

It reads from the next byte after writing a slave address and R/W bit. The register to read considers as the following address accessed at the end, and the data of the address that carried out the increment is read after it. If an address turns into the last address, the next byte will read out 00h. After the transmission end, the increment of the address is carried out.



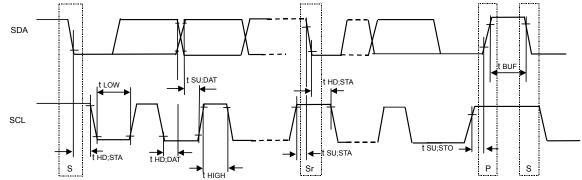
Multiple reading protocols

After specifying an internal address, it reads by repeated START condition and changing the data transfer direction. The data of the address that carried out the increment is read after it. If an address turns into the last address, the next byte will read out 00h. After the transmission end, the increment of the address is carried out.



As for reading protocol and multiple reading protocols, please do \overline{A} (not acknowledge) after doing the final reading operation. It stops with read when ending by A(acknowledge), and SDA stops in the state of Low when the reading data of that time is 0. However, this state returns usually when SCL is moved, data is read, and \overline{A} (not acknowledge) is done.

Timing diagram



●Electrical Characteristics(Unless otherwise specified, Ta=25 °C, VBAT=3.6V, VIO=1.8V)

Deremeter	Cumphel	Sta	Standard-mode			Fast-mode		
Parameter	Symbol	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
[I ² C BUS format]								
SCL clock frequency	fscl	0	-	100	0	-	400	kHz
LOW period of the SCL clock	tLOW	4.7	-	-	1.3	-	-	μs
HIGH period of the SCL clock	thigh	4.0	-	-	0.6	-	-	μs
Hold time (repeated) START condition After this period, the first clock is generated	thd;sta	4.0	-	-	0.6	-	-	μs
Set-up time for a repeated START condition	tsu;sta	4.7	-	-	0.6	-	-	μs
Data hold time	thd;dat	0	-	3.45	0	-	0.9	μs
Data set-up time	tsu;dat	250	-	-	100	-	-	ns
Set-up time for STOP condition	tsu;sto	4.0	-	-	0.6	-	-	μs
Bus free time between a STOP and START condition	tBUF	4.7	-	-	1.3	-	-	μs

Register List

Address				Regist	er data				Function	
Address	D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION	
00h	-	GRPSET2	GRPSET1	GRPSET0	-	-	-	SFTRST	Software Reset LED Lighting group Setting	
01h	-	LDO4EN	LDO3EN	LDO2EN	LDO1EN	FLLEDEN	SLEDEN	MLEDEN	Enable Control	
02h	-	-	-	IMLED4	IMLED3	IMLED2	IMLED1	IMLED0	Main LED Current Setting	
03h	-	-	-	ISLED4	ISLED3	ISLED2	ISLED1	ISLED0	Sub LED Current Setting	
04h	-	-	FLASHEN	IFLLED4	IFLLED3	IFLLED2	IFLLED1	IFLLED0	Flash LED Current Setting Flash mode Setting	
05h	LDO2VSEL3	LDO2VSEL2	LDO2VSEL1	LDO2VSEL0	LDO1VSEL3	LDO1VSEL2	LDO1VSEL1	LDO1VSEL0	LDO1 Vout Control LDO2 Vout Control	
06h	LDO4VSEL3	LDO4VSEL2	LDO4VSEL1	LDO4VSEL0	LDO3VSEL3	LDO3VSEL2	LDO3VSEL1	LDO3VSEL0	LDO3 Vout Control LDO4 Vout Control	

Input "0" for "-".

Prohibit to accessing the address that isn't mentioned.

Register Map

Address 00h < Software Reset, LED Lighting group Setting >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
00h	R/W	-	GRPSET2	GRPSET1	GRPSET0	-	-	-	SFTRST
Initial Value	00h	-	0	0	0	-	-	-	0

Bit7 : (Not used)

Bit [6:4] : GRPSET [2:0]

	(Main group)	(Sub group)	(Flash group)
"000":	LED1~4		LED5~7
"001":	LED1~4	LED5	LED6~7
"010":	LED1~4	LED5~6	LED7
"011":	LED1~4	LED5	LED7
"100":	LED1~5	LED6	LED7
"101":	LED1~5		LED6~7
"110":	LED1~6		LED7
"111":	LED1~6		LED7

Bit [3:1]: (Not used)

Bit0 : SFTRST

"0" : Reset cancel

"1": Reset (All register initializing)

Address 01h < Enable Control >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
01h	R/W	-	LDO4EN	LDO3EN	LDO2EN	LDO1EN	FLLEDEN	SLEDEN	MLEDEN
Initial Value	00h	-	0	0	0	0	0	0	0

- Bit7 : (Not used)
- Bit6 : LDO4EN "0" : LDO4 OFF "1" : LDO4 ON
- Bit5 : LDO3EN "0" : LDO3 OFF "1" : LDO3 ON
- Bit4 : LDO2EN "0" : LDO2 OFF "1" : LDO2 ON
- Bit3 : LDO1EN "0" : LDO1 OFF "1" : LDO1 ON
- Bit2 : FLLEDEN "0" : Flash LED OFF "1" : Flash LED ON
- Bit1 : SLEDEN "0" : Sub LED OFF "1" : Sub LED ON
- Bit0 : MLEDEN "0" : Main LED OFF
 - "1" : Main LED ON

Address 02h < Main LED Current Setting >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
02h	R/W	-	-	-	IMLED4	IMLED3	IMLED2	IMLED1	IMLED0
Initial Value	00h	-	-	-	0	0	0	0	0

Bit[7:5]: (Not used)

Bit[4:0] :	IMLED [4:0]		
	"00000":	0.9375 mA	(Initial value)
	"00001":	1.875 mA	
	"00010":	2.8125 mA	
	"00011":	3.75 mA	
	"00100":	4.6875 mA	
	"00101":	5.625 mA	
	"00110":	6.5625 mA	
	"00111":	7.5 mA	
	"01000":	8.4375 mA	
	"01001":	9.375 mA	
	"01010":	10.3125 mA	
	"01011":	11.25 mA	
	"01100":	12.1875 mA	
	"01101":	13.125 mA	
	"01110":	14.0625 mA	
	"01111":		
	"10000":	15.9375 mA	
		16.875 mA	
		17.8125 mA	
	"10011":	18.75 mA	
		19.6875 mA	
		20.625 mA	
	"10110":	21.5625 mA	
	"10111":		
		23.4375 mA	
		24.375 mA	
	"11010":	25.3125 mA	
		26.25 mA	
		27.1875 mA	
		28.125 mA	
		29.0625 mA	
	"11111":	30 mA	

* LED Current : 30 x 1/32 mA Step

Address 03h < Sub LED Current Setting >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
03h	R/W	-	-	-	ISLED4	ISLED3	ISLED2	ISLED1	ISLED0
Initial Value	00h	-	-	-	0	0	0	0	0

Bit[7:5]: (Not used)

Bit[4:0] :	ISLED [4:0]		
	"00000":	0.9375 mA	(Initial value)
	"00001":	1.875 mA	
	"00010":	2.8125 mA	
	"00011":	3.75 mA	
	"00100":	4.6875 mA	
	"00101":	5.625 mA	
	"00110":	6.5625 mA	
	"00111":	7.5 mA	
	"01000":	8.4375 mA	
	"01001":	9.375 mA	
		10.3125 mA	
	"01011":	11.25 mA	
	"01100":	12.1875 mA	
	"01101":	13.125 mA	
	"01110":	14.0625 mA	
	"01111":		
	"10000":	15.9375 mA	
	"10001":	16.875 mA	
	"10010":	17.8125 mA	
	"10011":	18.75 mA	
		19.6875 mA	
	"10101":	20.625 mA	
	"10110":	21.5625 mA	
	"10111":	22.5 mA	
	"11000":	23.4375 mA	
	"11001":	24.375 mA	
	"11010":	25.3125 mA	
	"11011":	26.25 mA	
	"11100":	27.1875 mA	
	"11101":	28.125 mA	
	"11110":	29.0625 mA	
	"11111":	30 mA	

* LED Current : 30 x 1/32 mA Step

Address 04h	< Flash LED Current Setting, Flash mode Setting >	
-------------	---	--

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
04h	R/W	-	-	FLASHEN	IFLLED4	IFLLED3	IFLLED2	IFLLED1	IFLLED0
Initial Value	00h	-	-	0	0	0	0	0	0

Bit[7:6]: (Not used)

Bit5 : FLASHEN

"0" : Flash mode OFF

"1": Flash mode ON (x4 normal mode)

Bit[4:0]: IFLLED [4:0]

	1		
	(At FLASHEN=0)	(At FLASHEN=1)	
"00000":	0.9375 mA,	3.75 mA	(Initial value)
	1.875 mA,	7.5 mA	
"00010":	2.8125 mA,	11.25 mA	
"00011":	3.75 mA,	15 mA	
"00100":	4.6875 mA,	18.75 mA	
"00101":	5.625 mA,	22.5 mA	
	6.5625 mA,	26.25 mA	
"00111":	7.5 mA,	30 mA	
"01000":	8.4375 mA,	33.75 mA	
"01001":	9.375 mA,	37.5 mA	
"01010":	10.3125 mA,	41.25 mA	
"01011":	11.25 mA,	45 mA	
"01100":	12.1875 mA,	48.75 mA	
"01101":	13.125 mA,	52.5 mA	
"01110":	14.0625 mA,	56.25 mA	
"01111":	15 mA,	60 mA	
"10000":	15.9375 mA,	63.75 mA	
"10001":	16.875 mA,	67.5 mA	
"10010":	17.8125 mA,	71.25 mA	
"10011":	18.75 mA,	75 mA	
"10100":	19.6875 mA,	78.75 mA	
"10101":	20.625 mA,	82.5 mA	
"10110":	21.5625 mA,	86.25 mA	
"10111":	22.5 mA,	90 mA	
"11000":	23.4375 mA,	93.75 mA	
"11001":	24.375 mA,	97.5 mA	
"11010":	25.3125 mA,	101.25 mA	
"11011":	26.25 mA,	105 mA	
"11100":	27.1875 mA.	108.75 mA	
"11101":	28.125 mA,	112.5 mA	
"11110":	29.0625 mA,	116.25 mA	
"11111":	30 mA,	120 mA	

* LED Current : 30 x 1/32 mA Step (at FLASHEN=0), 120 x 1/32 mA Step (at FLASHEN=1)

	Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
ſ	05h	R/W	LDO2VSEL3	LDO2VSEL2	LDO2VSEL1	LDO2VSEL0	LDO1VSEL3	LDO1VSEL2	LDO1VSEL1	LDO1VSEL0
I	Initial Value	74h	0	1	1	1	0	1	0	0

Address 05h < LDO1 Vout Control, LDO2 Vout Control >

Bit[7:4]: LDO2VSEL [3:0]

LDOZVSEL	[3.0]	
"0000":	1.20 V	
"0001":	1.30 V	
"0010":	1.50 V	
"0011":	1.60 V	
"0100":	1.80 V	
"0101":	2.20 V	
"0110":	2.40 V	
"0111":	2.50 V	(Initial value)
"1000":	2.60 V	
"1001":	2.70 V	
"1010":	2.80 V	
"1011":	2.90 V	
"1100":	3.00 V	
"1101":	3.10 V	
"1110":	3.20 V	
"1111":	3.30 V	

Bit[3:0]: LDO1VSEL [3:0]

"0000":	1.20 V	
"0001":	1.30 V	
"0010":	1.50 V	
"0011":	1.60 V	
"0100":	1.80 V	(Initial value)
"0101":	2.20 V	
"0110":	2.40 V	
"0111":	2.50 V	
"1000":	2.60 V	
"1001":	2.70 V	
"1010":	2.80 V	
"1011":	2.90 V	
"1100":	3.00 V	
"1101":	3.10 V	
"1110":	3.20 V	
"1111":	3.30 V	

I	Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
ſ	06h	R/W	LDO4VSEL3	LDO4VSEL2	LDO4VSEL1	LDO4VSEL0	LDO3VSEL3	LDO3VSEL2	LDO3VSEL1	LDO3VSEL0
I	Initial Value	A4h	1	0	1	0	0	1	0	0

Address 06h < LDO3 Vout Control, LDO4 Vout Control >

Bit[7:4]: LDO4VSEL [3:0]

LDO4V3EL	. [3.0]	
"0000":	1.20 V	
"0001":	1.30 V	
"0010":	1.50 V	
"0011":	1.60 V	
"0100":	1.80 V	
"0101":	2.20 V	
"0110":	2.40 V	
"0111":	2.50 V	
"1000":	2.60 V	
"1001":	2.70 V	
"1010":	2.80 V	(Initial value)
"1011":	2.90 V	
"1100":	3.00 V	
"1101":	3.10 V	
"1110":	3.20 V	
"1111":	3.30 V	

Bit[3:0]: LDO3VSEL [3:0]

"0000":	1.20 V	
"0001":	1.30 V	
"0010":	1.50 V	
"0011":	1.60 V	
"0100":	1.80 V	(Initial value)
"0101":	2.20 V	
"0110":	2.40 V	
"0111":	2.50 V	
"1000":	2.60 V	
"1001":	2.70 V	
"1010":	2.80 V	
"1011":	2.90 V	
"1100":	3.00 V	
"1101":	3.10 V	
"1110":	3.20 V	
"1111":	3.30 V	

Explanation for operate

1. Reset

There are two kinds of reset, software reset and hardware reset.

(1) Software reset

- · All the registers are initialized more than making a register (SFTRST) setup "1".
- The register of software resetting is an automatic return (Auto Return 0).
- (2) Hardware reset
 - It shifts to hardware reset by changing RESETB pin "H" \rightarrow "L".
 - The condition of all the registers under hardware reset pin is returned to the initial value, and it stops accepting all address.
 - It's possible to release from a state of hardware reset by changing RESETB pin "L" → "H".
 - RESETB pin has delay circuit. It doesn't recognize as hardware reset in "L" period under 5µs.
- (3) Reset Sequence

• When hardware reset was done during software reset, software reset is canceled when hardware reset is canceled. (Because the initial value of software reset is "0")

2. Thermal shutdown

The blocks which thermal shutdown function is effective in the following.

Charge pump LED Driver LDO1, LDO2, LDO3, LDO4

A thermal shutdown function works in about 190°C.

Detection temperature has a hysteresis, and detection release temperature is about 170°C. (Design reference value)

3. Charge Pump for LED driver

Charge Pump block is designed for the power supply for LED driver.

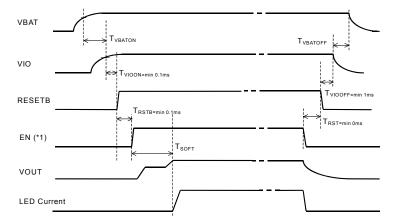
It has the x1.0/x1.33/x1.5/x2.0 mode. it changes to the most suitable mode automatically by Vf of LED and the battery voltage. It has the mode of x1.33 and it can be higher efficiency than traditional.

Start

Charge Pump circuit operates when any LED turns ON.

Soft start

When the start of the Charge Pump circuit is done, it has the soft start function to prevent a rush current.



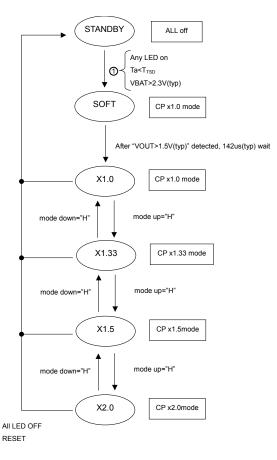
(*1) An EN signal in the upper figure means the following;

"EN is high" = Any LED turns ON

But if Ta >TSD, EN Signal doesn't become effective.

Charge Pump Mode transition

The transition of boost multiple transits automatically by Vf of LED and the battery voltage.



BD6085GUL changes the four charge pump movement mode automatically to realize low consumption power.

< Mode Up >

A LED terminal voltage is monitored, and the movement mode is changed to $\times 1 \rightarrow \times 1.33$, $\times 1.33 \rightarrow \times 1.5$ and $\times 1.5 \rightarrow \times 2$ automatically when a LED terminal voltage is lower than 0.2V (typ).

At this time, the maximum output voltage of the charge pump is restricted to 5.1V (typ).

< Mode Down >

The rise in the battery voltage, the off control of LED lighting and the data writing to the address 02h,03h,04h (LED Current Setting) is monitored, and the movement mode is changed to $\times 2 \rightarrow \times 1.5 \rightarrow \times 1.33 \rightarrow \times 1$ automatically at FLASHEN (Address 04h) ="0". This mode down movement lasts until a mode up movement happens. At FLASHEN="1", the mode down doesn't happen.

The thresholds of rise in a battery voltage are 2.9V, 3.3V, 3.7V and 4.1V (typ).

And, as for the off control of LED lighting, it is shown that MLEDEN, SLEDEN and FLLEDEN (Address 01h) and FLASHEN (Address 04h) transited in "1" \rightarrow "0".

Over Voltage protection / Over Current protection

Charge Pump circuit output (VOUT) is equipped with the over-voltage protection and the over current protection function. A VOUT over-voltage detection voltage is about 5.5V(typ). (VOUT at the time of rise in a voltage)

A detection voltage has a hysteresis, and a detection release voltage is about 5.1V(typ).

And, when VOUT output short to ground, input current of the battery terminal is limited by an over current protection function.

4. LED Driver

LED current value setting (for Main/Sub) Internal circuit fixes maximum current value of LED. LED current is maximum 30mA/ch.

LED current value setting (for Flash)

Internal circuit fixes maximum current value of LED. When FLASHEN (Address 04h)=0, LED current is maximum 30mA/ch. (Normal mode) When FLASHEN (Address 04h)=1, LED current change to x4 of Normal mode. (Flash mode) At Normal mode, it can use for LCD Backlight or Torch mode of Flash. At Flash mode, it can use for LED Flash.

The number of LED Lighting

The number of lighting for Main/Sub/Flash LED can be set up grouping by the register GRPSET* (Address 00h).

The setting of the number of lighting is as the following.

The grouping of LED (Main/Sub/Flash) is independently controlled by register MLEDEN, SLEDEN, FLLEDEN (Address 01h).

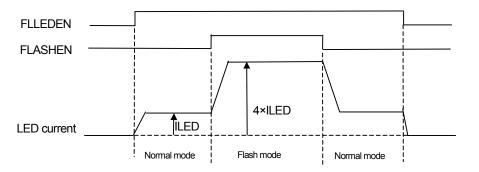
Grouping setting	LED1	LED2	LED3	LED4	LED5	LED6	LED7	Main/Sub/Flash
(0,0,0)	Main	Main	Main	Main	Flash	Flash	Flash	4/0/3
(0,0,1)	Main	Main	Main	Main	Sub	Flash	Flash	4 / 1 / 2
(0,1,0)	Main	Main	Main	Main	Sub	Sub	Flash	4 / 2 / 1
(0,1,1)	Main	Main	Main	Main	Sub	-	Flash	4/1/1
(1,0,0)	Main	Main	Main	Main	Main	Sub	Flash	5/1/1
(1,0,1)	Main	Main	Main	Main	Main	Flash	Flash	5/0/2
(1,1,0)	Main	Main	Main	Main	Main	Main	Flash	6/0/1
(1,1,1)	Main	Main	Main	Main	Main	Main	Flash	6 / 0 / 1

Grouping setting (*,*,*) means ("GRPSET2","GRPSET1","GRPSET0").

The change of the Grouping setting with turning it on is prohibited. The LED terminal that isn't used must be connected to the ground.

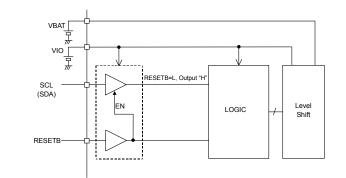
Normal mode/Flash mode

Normal mode and Flash mode change as the figure of the follow. ILED is set by the register.

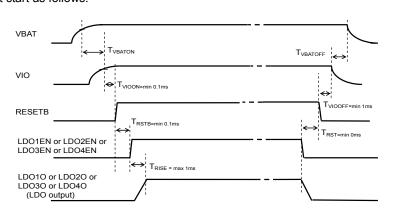


5. I/O

When the RESETB pin is Low, the input buffers (SDA and SCL) are disable for the Low consumption power.



6. About the start of LDO1~LDO4 It must start as follows.



<Start Sequence>

VBAT ON (Enough rise up) \rightarrow VIO ON (Enough rise up) \rightarrow Reset release \rightarrow LDO ON

(Register access acceptable)

<End Sequence>

LDO OFF \rightarrow Reset \rightarrow VIO OFF (Enough fall down) \rightarrow VBAT OFF

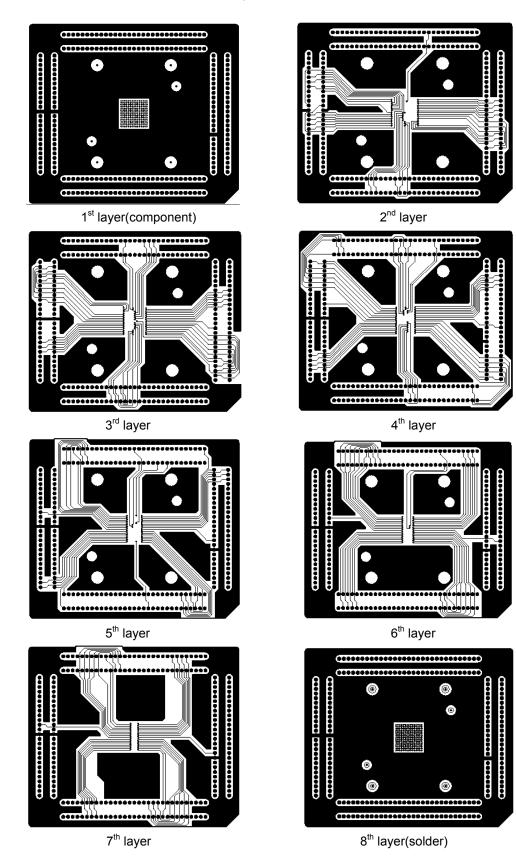
7. About the terminal management of the function that isn't used Set up the terminal that isn't used as follows.

The LED terminal which isn't used : Short to ground

Don't do the control concerned with this terminal.

- T1, T2 : Short to ground
- T3, T4 : Open

●PCB pattern of the Power dissipation measuring board



Cautions on use

(1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

(2) Power supply and ground line

Design PCB pattern to provide low impedance for the wiring between the power supply and the ground lines. Pay attention to the interference by common impedance of layout pattern when there are plural power supplies and ground lines. Especially, when there are ground pattern for small signal and ground pattern for large current included the external circuits, please separate each ground pattern. Furthermore, for all power supply pins to ICs, mount a capacitor between the power supply and the ground pin. At the same time, in order to use a capacitor, thoroughly check to be sure the characteristics of the capacitor to be used present no problem including the occurrence of capacity dropout at a low temperature, thus determining the constant.

(3) Ground voltage

Make setting of the potential of the ground pin so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no pins are at a potential lower than the ground voltage including an actual electric transient.

(4) Short circuit between pins and erroneous mounting

In order to mount ICs on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can break down the ICs. Furthermore, if a short circuit occurs due to foreign matters entering between pins or between the pin and the power supply or the ground pin, the ICs can break down.

(5) Operation in strong electromagnetic field

Be noted that using ICs in the strong electromagnetic field can malfunction them.

(6) Input pins

In terms of the construction of IC, parasitic elements are inevitably formed in relation to potential. The operation of the parasitic element can cause interference with circuit operation, thus resulting in a malfunction and then breakdown of the input pin. Therefore, pay thorough attention not to handle the input pins, such as to apply to the input pins a voltage lower than the ground respectively, so that any parasitic element will operate. Furthermore, do not apply a voltage to the input pins when no power supply voltage is applied to the IC. In addition, even if the power supply voltage is applied, apply to the input pins a voltage lower than the power supply voltage or within the guaranteed value of electrical characteristics.

(7) External capacitor

In order to use a ceramic capacitor as the external capacitor, determine the constant with consideration given to a degradation in the nominal capacitance due to DC bias and changes in the capacitance due to temperature, etc.

(8) Thermal shutdown circuit (TSD)

This LSI builds in a thermal shutdown (TSD)circuit. When junction temperatures become detection temperature or higher, the thermal shutdown circuit operates and turns a switch OFF. The thermal shutdown circuit, which is aimed at isolating the LSI from thermal runaway as much as possible, is not aimed at the protection or guarantee of the LSI. Therefore, do not continuously use the LSI with this circuit operating or use the LSI assuming its operation.

(9) Thermal design

Perform thermal design in which there are adequate margins by taking into account the permissible dissipation (Pd)in actual states of use.

(10) LDO

Use each output of LDO by the independence. Don't use under the condition that each output is short-circuited because it has the possibility that an operation becomes unstable.

(11) About the pin for the test, the un-use pin

Prevent a problem from being in the pin for the test and the un-use pin under the state of actual use. Please refer to a function manual and an application notebook. And, as for the pin that doesn't specially have an explanation, ask our company person in charge.

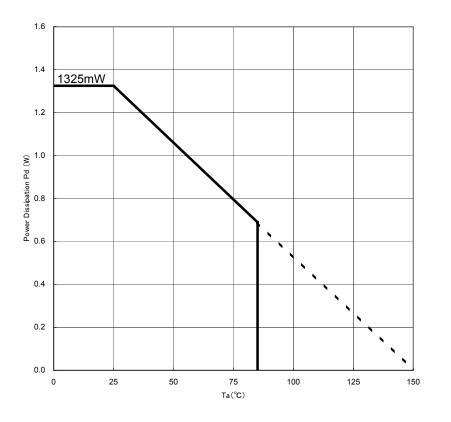
(12) About the rush current

For ICs with more than one power supply, it is possible that rush current may flow instantaneously due to the internal powering sequence and delays. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of wiring.

(13) About the function description or application note or more.

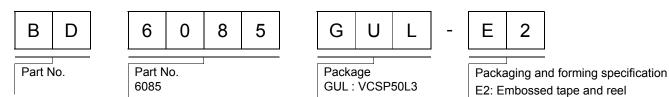
The function description and the application notebook are the design materials to design a set. So, the contents of the materials aren't always guaranteed. Please design application by having fully examination and evaluation include the external elements.

Power dissipation (On the ROHM's standard board)

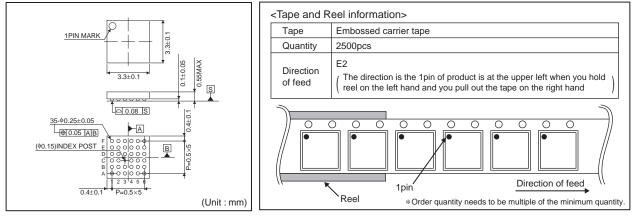


Information of the ROHM's standard board Material : glass-epoxy Size : Refer to after page.

Ordering part number



VCSP50L3(BD6085GUL)



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